



APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	METHOD OF FORMING A SEMICONDUCTOR DEVICE HAVING AIR GAPS AND THE STRUCTURE SO FORMED		
Application Type : regular, utility Attorney Docket Number : BUR920030189US1			
Correspondence address: Customer Number: 30,449			
			
Inventor Information: <u>Inventor 1:</u> Applicant Authority Type: Inventor Citizenship: US Given Name: Anthony Middle Name: K. Family Name: Stamper Residence: City of Residence: Williston State of Residence: VT Country of Residence: US Address-1 of Mailing Address: 46 Evergreen Drive Address-2 of Mailing Address: City of Mailing Address: Williston State of Mailing Address: VT Postal Code of Mailing Address: 05495 Country of Mailing Address: US Phone: Fax: E-mail:			
Attorney Information: practitioner(s) at Customer Number: 30449			
 as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.			

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